

	Application No.	Applicant(s)
	10/625 250	CRANT WILLIAM
Notice of Allowability	10/635,359 <b>Examiner</b>	GRANT, WILLIAM  Art Unit
	Non No	0044
	Ngan Ngo	2814
The MAILING DATE of this communication apper All claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RI of the Office or upon petition by the applicant. See 37 CFR 1.313	(OR REMAINS) CLOSED in this ap or other appropriate communication GHTS. This application is subject t	plication. If not included not be mailed in due course. <b>THIS</b>
1. This communication is responsive to		
2. The allowed claim(s) is/are <u>1-20</u> .		
3. $\boxtimes$ The drawings filed on <u>06 August 2003</u> are accepted by the	Examiner.	
4. Acknowledgment is made of a claim for foreign priority unexpense and the complex co	been received.  been received in Application No cuments have been received in this  of this communication to file a reply lENT of this application.  itted. Note the attached EXAMINER es reason(s) why the oath or declar of the submitted.  son's Patent Drawing Review (PTO)  s Amendment / Comment or in the of  .84(c)) should be written on the drawing he header according to 37 CFR 1.121  sit of BIOLOGICAL MATERIAL	national stage application from the complying with the requirements  A'S AMENDMENT or NOTICE OF ation is deficient.  -948) attached  Office action of ings in the front (not the back) of (d).  must be submitted. Note the
<ul> <li>Attachment(s)</li> <li>1. ☑ Notice of References Cited (PTO-892)</li> <li>2. ☐ Notice of Draftperson's Patent Drawing Review (PTO-948)</li> <li>3. ☐ Information Disclosure Statements (PTO-1449 or PTO/SB/O Paper No./Mail Date</li></ul>	6.  Interview Summary Paper No./Mail Da Paper No	ate

## Reasons for Allowance

The following is an examiner's statement of reasons for allowance:

The prior arts of record do not show the power module comprising a lead frame including a conductive pad for receiving at least one power semiconductor device, a heat sink and a thermally conductive material interposed between and indirect contact with an open surface of the conductive pad and the heat sink in which heat generated by the semiconductor device travels through the conductive pad and the thermally conductive material and is dissipated by the heat sink.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Any inquiry concerning this communication should be directed to Examiner Ngan Ngo at telephone number (571) 272-1711. The fax number for the Art unit is (703) 308-7722.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0956.

Ngan Van Ngo Primary Examiner